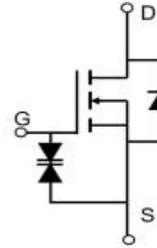


Description

Features

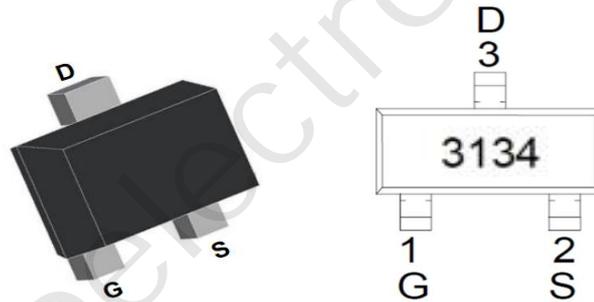
- 20V, 0.8A
 $R_{DS(ON)}$ Typ = 111mΩ @ $V_{GS} = 4.5V$
 $R_{DS(ON)}$ Typ = 170mΩ @ $V_{GS} = 2.5V$
- Advanced Trench Technology
- Excellent $R_{DS(ON)}$ and Low Gate Charge
- Lead Free
- ESD Protected: 2KV



Schematic Diagram

Application

- Load Switch
- PWM Application
- Power Management



Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMLETU3134K	3134	SOT-723-3L	TAPING	7"	8000	320000

Absolute Maximum Ratings (@ $T_J = 25^\circ C$ unless otherwise specified)

Symbol	Parameter	Value	Units
V_{DS}	Drain-to-Source Voltage	20	V
V_{GS}	Gate-to-Source Voltage	±10	V
I_D	Continuous Drain Current	$T_A = 25^\circ C$	0.8
		$T_A = 100^\circ C$	0.48
I_{DM}	Pulsed Drain Current ⁽¹⁾	3.2	A
P_D	Power Dissipation	$T_A = 25^\circ C$	0.16
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient ⁽²⁾	801	$^\circ C/W$
T_J, T_{STG}	Junction & Storage Temperature Range	-55 to 150	$^\circ C$

Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
V _{(BR)DSS}	Drain-Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	20	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 20V, V _{GS} = 0V	-	-	1.0	μA
I _{GSS}	Gate-Body Leakage Current	V _{DS} = 0V, V _{GS} = ±10V	-	-	±10	μA
On Characteristics						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250μA	0.4	0.65	1	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} = 4.5V, I _D = 0.5A	-	111	144	mΩ
		V _{GS} = 2.5V, I _D = 0.3A	-	170	221	mΩ
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{GS} = 0V, V _{DS} = 10V, f = 1MHz	-	53	-	pF
C _{oss}	Output Capacitance		-	14	-	pF
C _{riss}	Reverse Transfer Capacitance		-	10	-	pF
Q _g	Total Gate Charge	V _{GS} = 0 to 4.5V V _{DS} = 10V, I _D = 0.8A	-	1	-	nC
Q _{gs}	Gate Source Charge		-	0.28	-	nC
Q _{gd}	Gate Drain("Miller") Charge		-	0.22	-	nC
Switching Characteristics						
t _{d(on)}	Turn-On DelayTime	V _{GS} = 4.5V, V _{DD} = 10V I _D = 0.5A, R _{GEN} = 10Ω	-	2	-	ns
t _r	Turn-On Rise Time		-	19	-	ns
t _{d(off)}	Turn-Off DelayTime		-	10	-	ns
t _f	Turn-Off Fall Time		-	23	-	ns
Drain-Source Diode Characteristics and Max Ratings						
I _S	Maximum Continuous Drain to Source Diode Forward Current		-	-	0.8	A
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	3.2	A
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 0.8A	-	-	1.2	V

- Notes:
1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
 2. R_{θJA} is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB
 3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 0.5%.

Typical Performance Characteristics

Figure 1: Output Characteristics

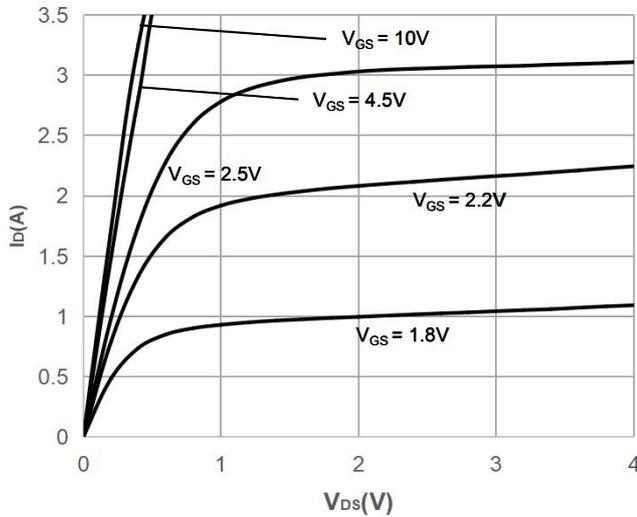


Figure 2: Typical Transfer Characteristics

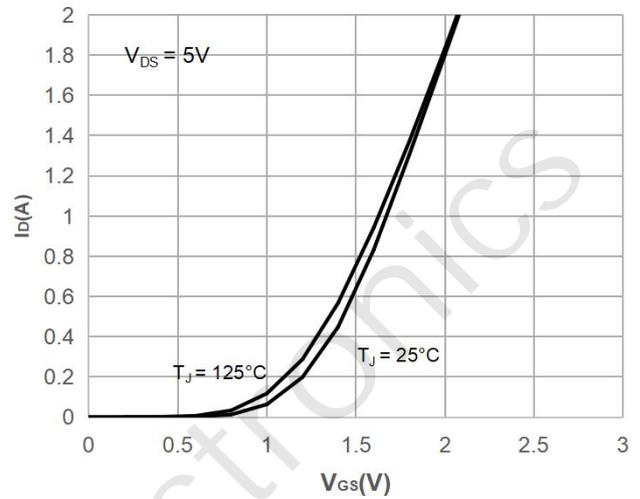


Figure 3: On-resistance vs. Drain Current

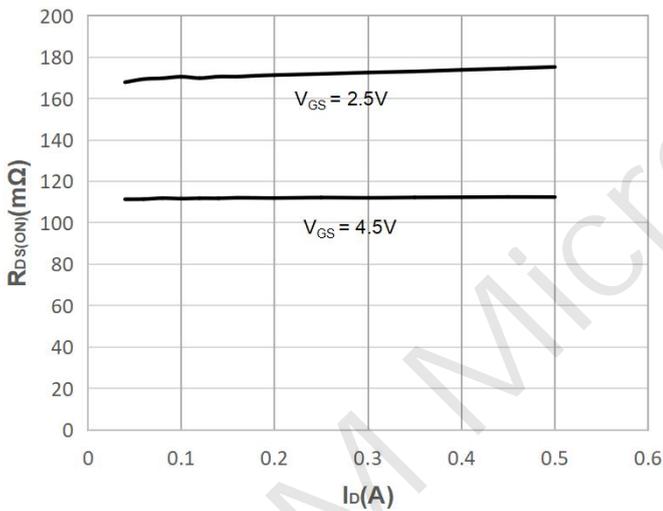


Figure 4: Body Diode Characteristics

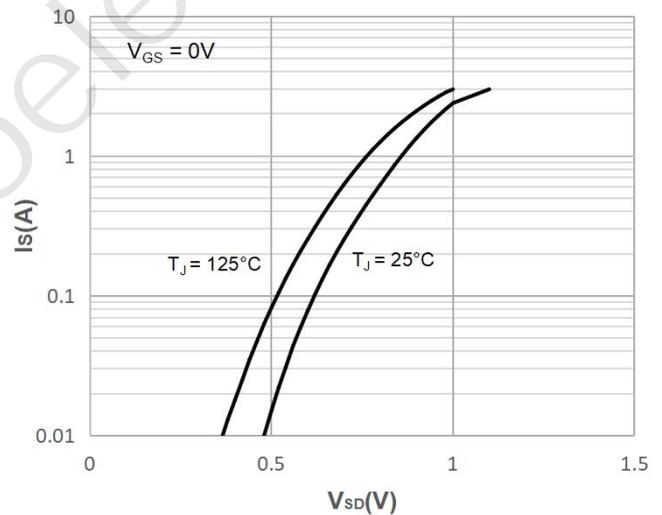


Figure 5: Gate Charge Characteristics

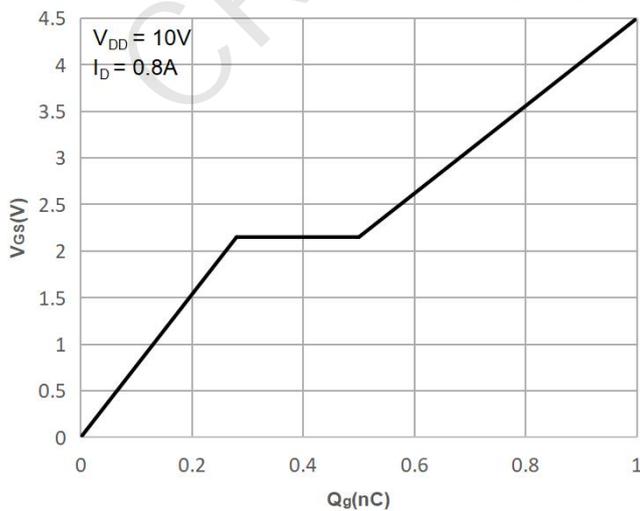
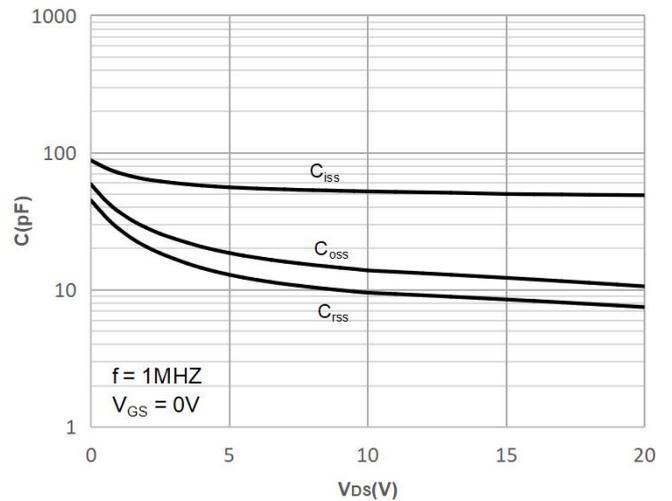


Figure 6: Capacitance Characteristics



Typical Performance Characteristics

Figure 7: Normalized Breakdown voltage vs. Junction Temperature

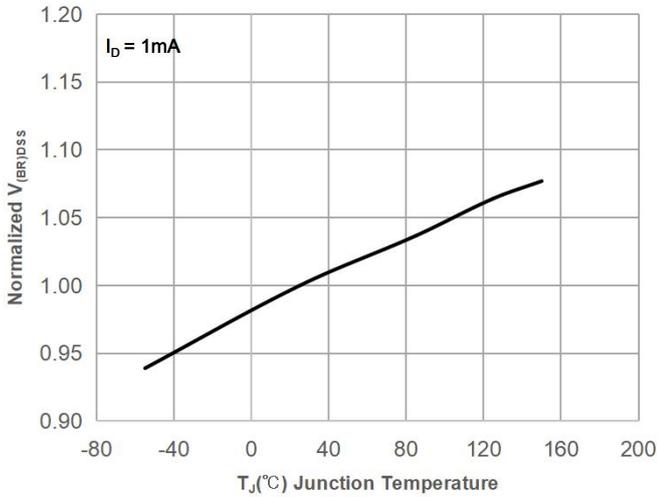


Figure 8: Normalized on Resistance vs. Junction Temperature

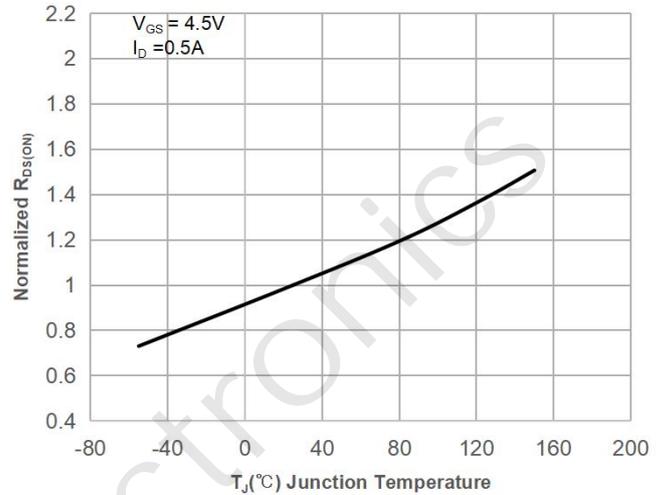


Figure 9: Maximum Safe Operating Area

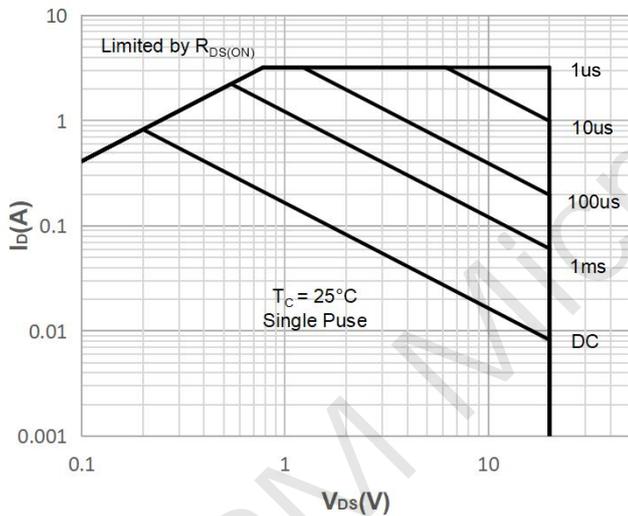


Figure 10: Maximum Continuous Driian Current vs. Case Temperature

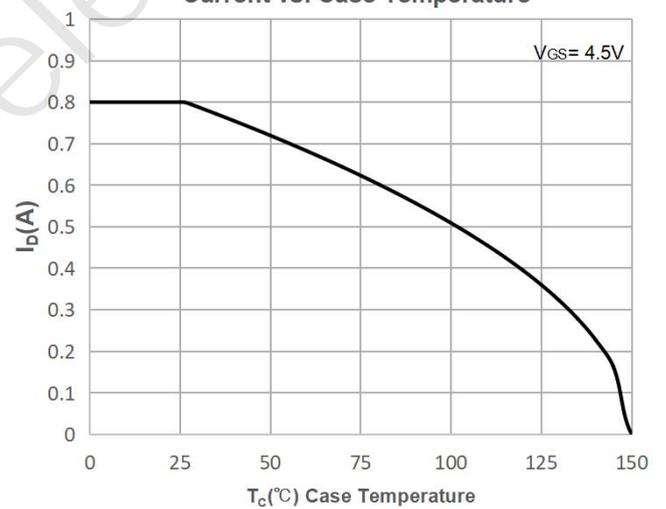


Figure 11: Normalized Maximum Transient Thermal Impedance

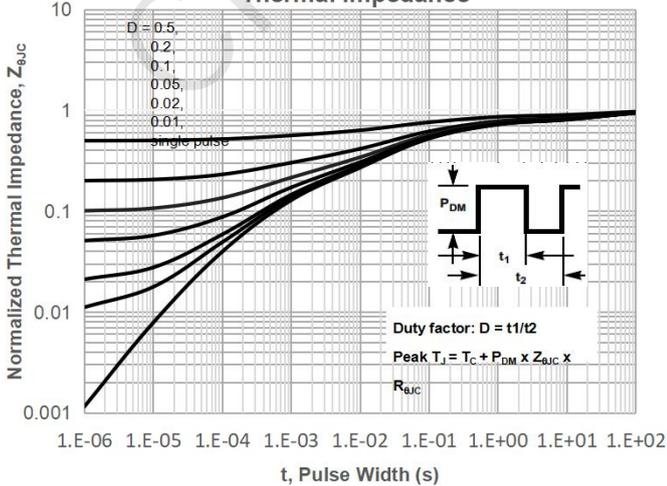
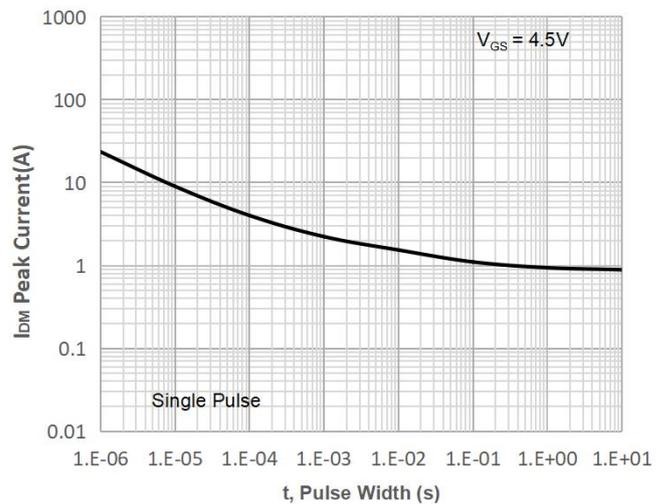


Figure 12: Peak Current Capacity



Test Circuit

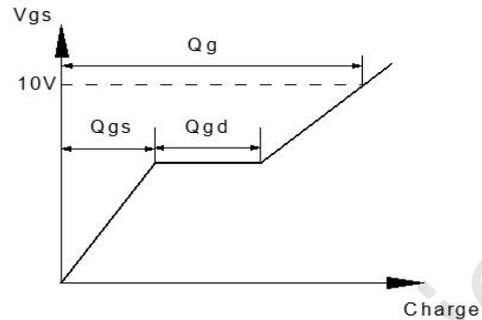
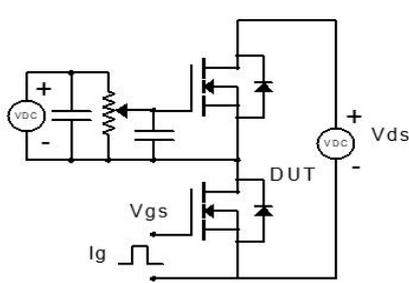


Figure 1: Gate Charge Test Circuit & Waveform

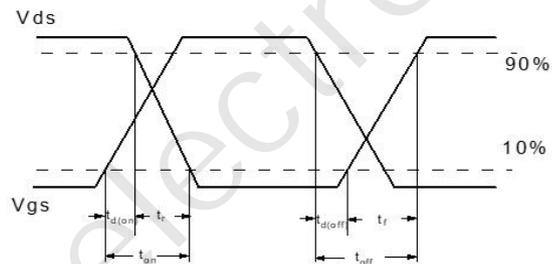
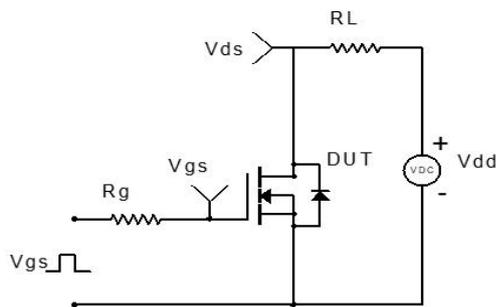


Figure 2: Resistive Switching Test Circuit & Waveform

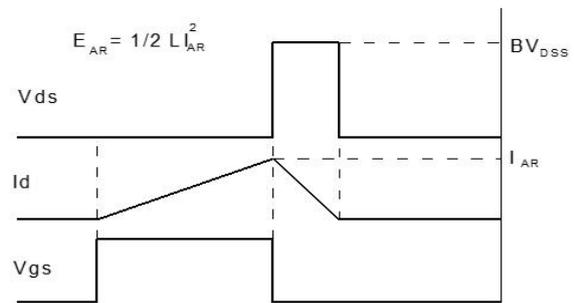
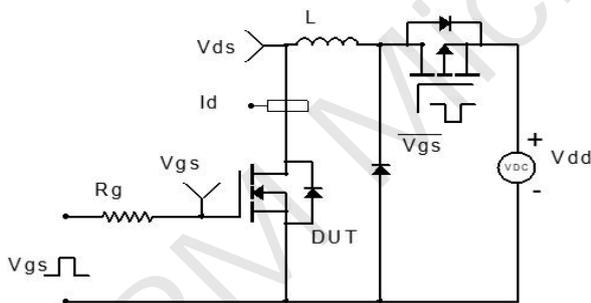


Figure 3: Unclamped Inductive Switching Test Circuit & Waveform

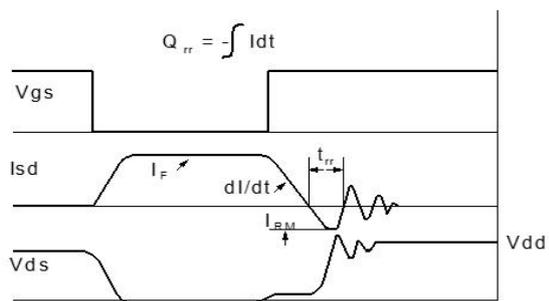
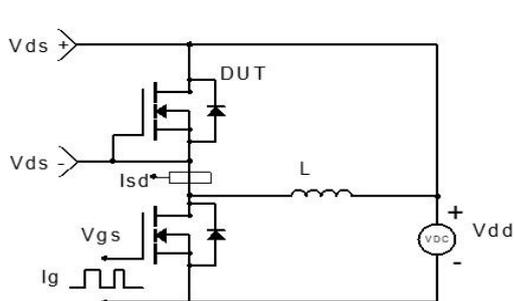
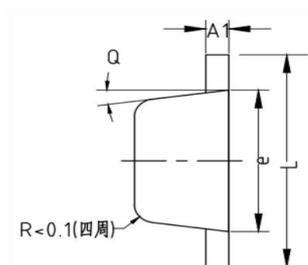
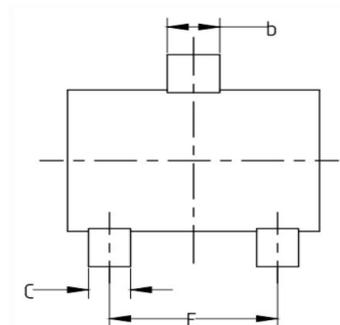
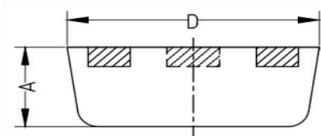


Figure 4: Diode Recovery Test Circuit & Waveform

Package Mechanical Data(SOT-723-3L)



PKG	COMMON DIMENSION (MM)		
	SOT-723-3L		
SYMBOL	MIN	NOM	MAX
A	0.420	0.450	0.480
A1	0.100	0.110	0.120
b	0.230	0.250	0.280
c	0.180	0.200	0.235
D	1.150	1.200	1.300
F	0.750	0.800	0.850
L	1.170	1.200	1.240
e	0.750	0.800	0.850
Q	8°		

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